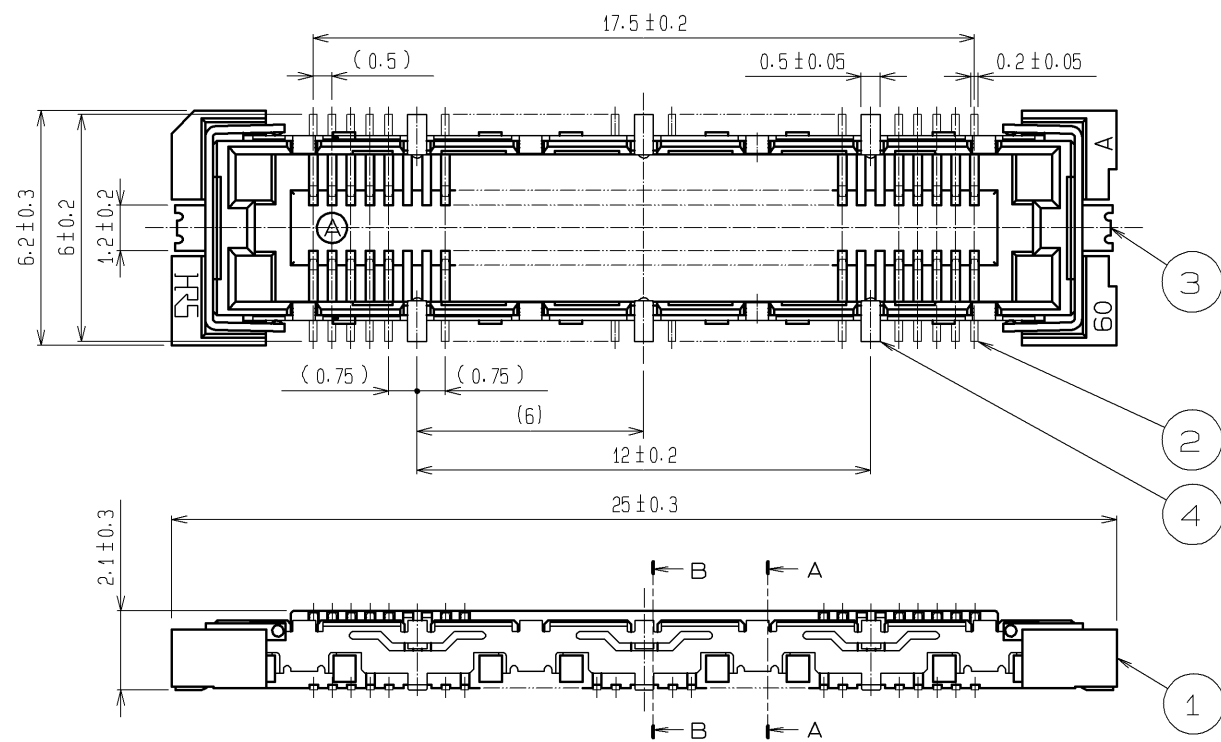
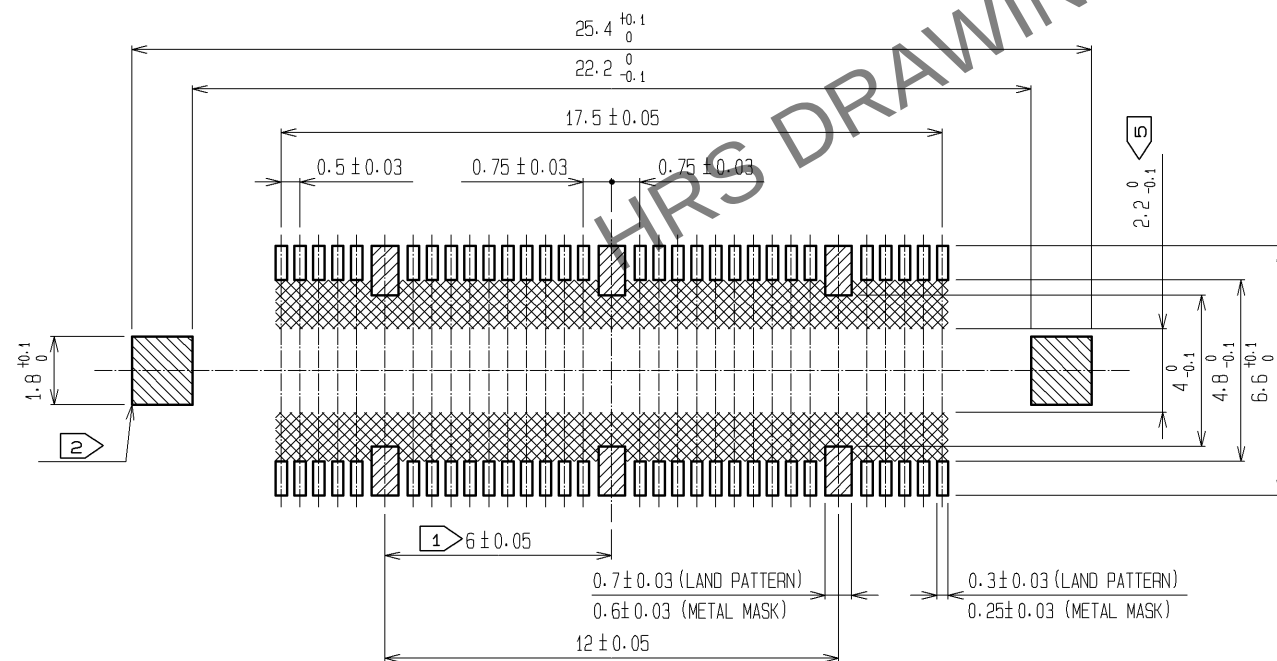
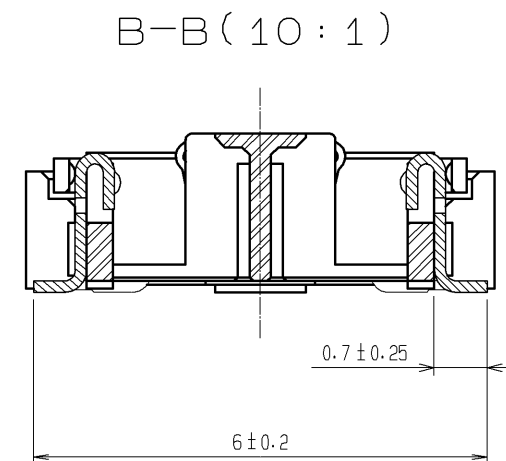
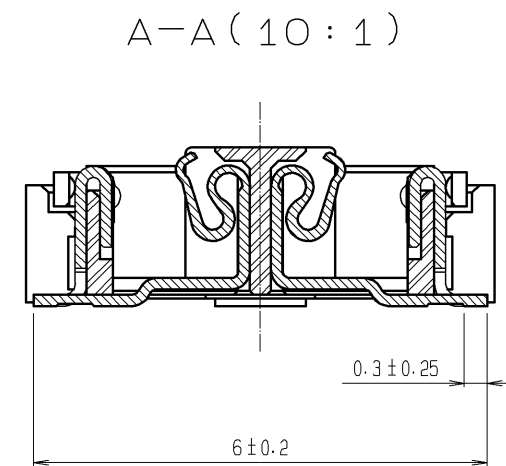
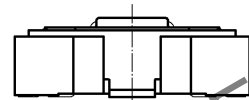




RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS:0.15mm)



- NOTES
- 1 6 HATCHED  PARTS:GROUND CIRCUIT.
 - 2 2 HATCHED  PARTS:GROUND CIRCUIT.
 - 3 SMT LEAD-COPLANARITY:0.1 MAX.
 - 4 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - 5 MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND ,OR LEAD MAY TOUCH PATTERN.(THIS APPLIES TO HATCHED  AREA.)
 - 6 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.



					2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.				
3. 4		PHOSPHOR BRONZE	TIN PLATING				LEAD AREA : GOLD 0.05μm min.				
1		LCP	BEIGE UL94V-0				UNDER PLATING : NICKEL 1μm min.				
NO.		MATERIAL		FINISH . REMARKS		NO.	MATERIAL		FINISH . REMARKS		
UNITS mm				SCALE 5 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA				12. 03. 08		DRAWING NO.		EDC3-152636-25	
		CHECED : HT. YAMAGUCHI				12. 03. 08		PART NO.		FX11B-60S/6-SV(71)	
		DESIGNED : TS. MIYAKI				12. 03. 08		CODE NO.		CL573-0712-2-71	
		DRAWN : TS. MIYAKI				12. 03. 08				 1/1	